

TFT-LCD Module Specification

Module NO.: TST043WVBI-130

Version: V1.0

□ APPROVAL FOR SPECIFICATION

□ APPROVAL FOR SAMPLE

For Customer's Acceptance:				
Approved by	Comment			

eam Source Display:		
Presented by	Reviewed by	Organized by

Version No.	Date	Content	Remark
V1.0	2022-02-17	Initial Release	

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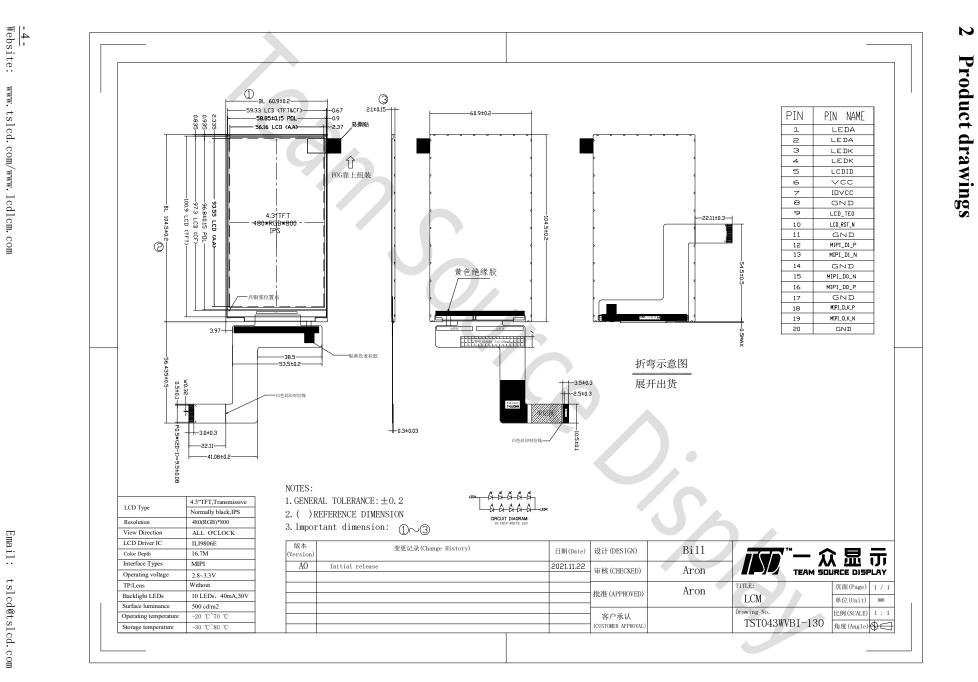
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1 General Characteristics

ITEM	Specification	Unit
LCD Type	a-Si TFT, Transmissive, Normally black, IPS	-
LCD Size	4.3	inch
Resolution (W x H)	480 x (RGB) × 800	pixel
LCM outline	60.9(W) x 104.5(H) x2.1(D)	mm
Active Area	56.16 (W) x 93.55(H)	mm
Pixel Pitch	0.117(H)x0.117(V)	mm
Viewing Direction	ALL o'clock	
Color Depth	16.7M	
Pixel Arrangement	RGB	
Backlight Type	10 LEDs, 40mA	-
Surface Treatment	Clear	-
Interface Type	MIPI	-
Input Voltage	2.8~3.3	V
With/Without TP	Without	-
Weight	TBD	g

Note 1: RoHS compliant Note 2: LCM weight tolerance: ± 5%.





www.tslcd.com/www.lcdlcm.com

LCM Specifications(TST043WVBI-130)

显示 λλ TEAM SOURCE DISPLAY

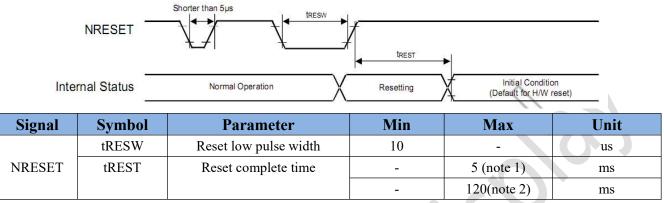
3 Interface description

Pin No.	Symbol	I/O	Functional	Remark				
1	LEDA	Р	LED Power supply +					
2	LEDA	P	LED Power supply +					
3	LEDK	Р	LED Power supply -					
4	LEDK	P	LED Power supply -					
5	LCDID		No Connection.					
6	VCC	Р	Analog voltage, 2.5-3.6V					
7	VDDIO	Р	I/O supply voltage, 1.65~3.6V					
8	GND	Р	System ground.					
9	LCD_TE0	0	Tearing effect output					
10	LCD_RST_N		External reset input					
11	GND	P	System ground.					
12	MIPI_D1_P	I/O	DSI differential data1 +					
13	MIPI_D1_N	I/O	DSI differential data1 -					
14	GND	P	System ground.					
15	MIPI_D0_N	I/O	DSI differential data0 -					
16	MIPI_D0_P	I/O	DSI differential data1 +					
17	GND	Ρ	System ground.					
18	MIPI_CLK_P	I/O	DSI differential clock +					
19	MIPI_CLK_N	I/O	DSI differential clock -					
20	GND	P	System ground.					



4 LCM Interface Timing

4.1 Reset Timing



Note: (1) When reset applied during SLPIN mode;

(2) When reset applied during SLPOUT mode.

4.2 DSI protocol

The protocol layer appends packet-protocol information and headers. The receiver side of a DSI Link performs the converse of the transmitter side, decomposing the packet into parallel data, signal events and commands. The DSI protocol permits multiple packets which is useful for events such as peripheral initialization, where many registers may be loaded separate write commands at system startup. Figure 4.35 illustrates multiple HS Transmission packets.

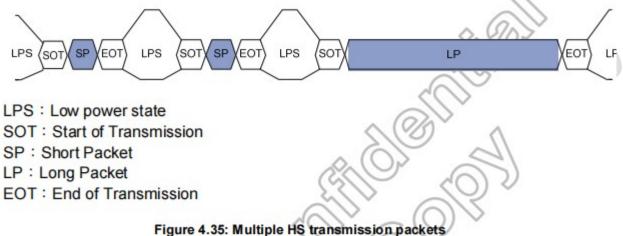
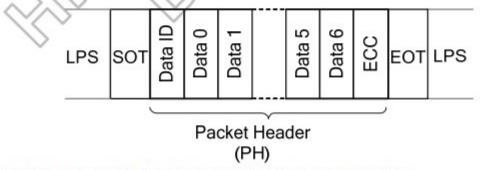


Figure 4.55. Multiple HS transmission packets

The packet includes two types which are Long packet and short packet. The first byte of the packet, the Data Identifier (DI), includes information specifying the length of the packet. Command Mode systems send commands and an associated set of parameters, with the number of parameters depending on the command type.

Short packets specify the payload length using the Data Type field and are from two to nine bytes in length. Short packet is used for most Command Mode commands and associated parameters. Where short packets format include an 8-bit Data ID followed by zero to seven bytes and an 8-bit ECC. Figure 4.36 shows the structure of the Short packet.

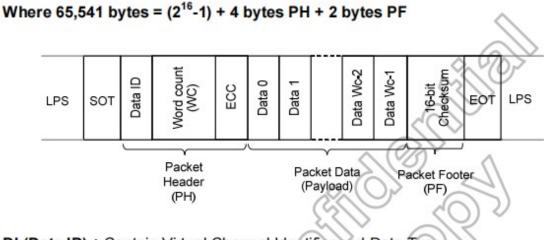


DI(Data ID): Contain Virtual Channel Identifier and Data Type. **ECC(Error Correction Code)**: The Error Correction Code allows single-bit errors to be corrected and 2-bit errors to be detected in the Packet Header.

Figure 4.36: Structure of the short packet



Long packets specify the payload length using a two-byte Word Count field and then the payload maybe from 0 to 65,541 bytes in length. Long packets permit transmission of large blocks of pixel or other data.. Figure 4.37 shows the structure of the Long packet. Long Packet Header composed of three elements: an 8-bit Data Identifier, a 16-bit Word Count, and 8-bit ECC. The Packet Footer has one element, a 16-bit checksum. Long packets can be from 6 to 65,541 bytes in length.



DI (Data ID) : Contain Virtual Channel Identifier and Data Type.

WC (Word Count) : The receiver use WC to define packet end.

ECC (Error Correction Code) : The Error Correction Code allows single-bit errors to be corrected and 2-bit errors to be detected in the Packet Header.

PF(Packet Footer) : Mean 16-bit Checksum.

Figure 4.37: Structure of the long packet

According to packet form, basic elements include DI and ECC. Figure 4.38 the shows format of Data ID.

a second de la	A 40	N	NU.				Constant Sector Sector	
DI7	D16	DI5	DI4	DI3	DI2	DI1	DIO	
VC (Virtua	al Channel)	DT (Data T	Гуре)					
_	~ /. \ V		V /					

DI[7:6] → These two bits identify the data as directed to one of four virtual channels. DI[5:0]: These six bits specify the Data Type, which specifies the size, format and, in some cases, the interpretation of the packet contents.

Figure 4.38: The format of data ID.



Due to Data Type (DT) mean format of transmission type, Figure 4.39 show Short- / Long-packet transmission command sequence.

Long packet write Command / Parameters / Pixel Datas

PH WR CMD / CMD + PAs LPS EOT PF LPS SOT ECC DI CMD+ Pixel DATA WC → Write number of Payload Data. Ex: One CMD write, WC setting as 1. CMD + PAs write, WC setting as number of (CMD+PAs). CMD + DATA write, WC setting as number of (CMD + Pixel DATA) Short packet write Command / Parameters LPS LPS DCS WR CMD / CMD + PAs SOT DI ECC EOT DI → Write suitable Data type. Ex: One CMD write, DI + DCS WR CMD CMD + PAs write, DI + DCS WR CMD + PAs Figure 4.39: show Short- / Long-packet transmission command sequence



5 Absolute Maximum Ratings

PARAMETER	SYMBOL	MIN	MAX	UNIT
Supply Voltage (Analog)	VCI~GND	-0.3	+4.6	V
Logic signal voltage(I/O)	IOVCC~GND	-0.3	+4.6	V
Operating Temperature	ТОР	-20	70	°C
Storage Temperature	TST	-30	80	°C
Humidity	RH	-	90%(Max 60° C)	RH

6 Electrical Characteristics

D (2.5 1.65 -	2.8 1.8 TBD	3.6 VCI	V V mA
	-			
	-	TBD		mA
и (
	0.7IOVCC	-	IOVCC	
L	GND		0.3IOVCC	V
H (0.8IOVCC	-	IOVCC	v
)L	GND		0.2IOVCC	
	H	H 0.8IOVCC	Н 0.8IOVCC -	H 0.8IOVCC - IOVCC

7 Backlight Characteristics

ITEM	SYMBOL	MIN	ТҮР	MAX	UNIT
Voltage for LED backlight	V_{f}	-	30	-	V
Current for LED backlight	$I_{\rm f}$	-	40	-	mA
Power consumption	Wbl	-	1200	-	mW
Uniformity	Avg	80	-	-	%
LED Life Time	-	30000	40000	-	Hrs

Note:

1. The LED life time is defined as the module brightness decrease to 50% original brightness at Ta=25°C, 60% RH \pm 5 %.

2. The life time of LED will be reduced if LED is driven by high current, high ambient temperature and humidity conditions.

3. Typical operating life time is an estimated data.

4. Permanent damage to the device may occur if maximum values are exceeded or reverse voltage is loaded .Functional operation should be restricted to the conditions described under normal operating conditions.

8 LCD Optical specifications

Itom	Symbol	Conditio	5	Specificati	on	II	Remark
Item	Symbol	n	Min	Тур	Max	Unit	кешагк
Response time (By Quick)	Tr+Tf	$\theta = 0^{\circ}$	-	35	-	ms	Note 5
Contrast ratio	CR	$\theta = 0^{\circ}$	650	800	-		Note 2,6
	Тор	$CR \ge 10$	-	80	-		
XV:iu	Bottom	$CR \ge 10$	-	80	-		N. 4. 2 (7
Viewing angle	Left	$CR \ge 10$	-	80	-	Deg.	Note 2,6,7
	Right	$CR \ge 10$	-	80	-		
	Wx		0.26	TBD	0.31		
	Wy		0.26	TBD	0.31		
	Rx			TBD			
Color Filter	Ry			TBD			N. 4. 2
Chromacicity	Gx			TBD		K	Note 3
with C light	Gy	$\theta = 0^{\circ}$		TBD			
	Bx	0 - 0		TBD			
	By			TBD			
Transmittance	Trans		-	4.3%	-		Note 4

Note 1: Ambient temperature = 25° C.

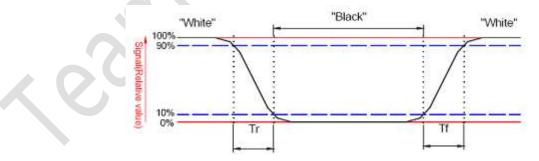
Note 2: To be measured with a viewing cone of 2°by Topcon luminance meter BM-5A.

Note 3: To be measured with Otsuta chromaticity meter LCF-2100M, CF only measure under C light simulation.

Note 4: CTC shipping status is cell without polarizer. Transmittance of Specification is cell with polarizer. The tolerance of Transmittance is $\pm 10\%$.

Note 5: Definition of response time:

The output signals of TRD-100 are measured when the input signals are changed to "White" (falling time) and from "White" to "Black" (rising time), respectively. The interval is between the 10% and 90% of amplitudes. Refer to figure as below.



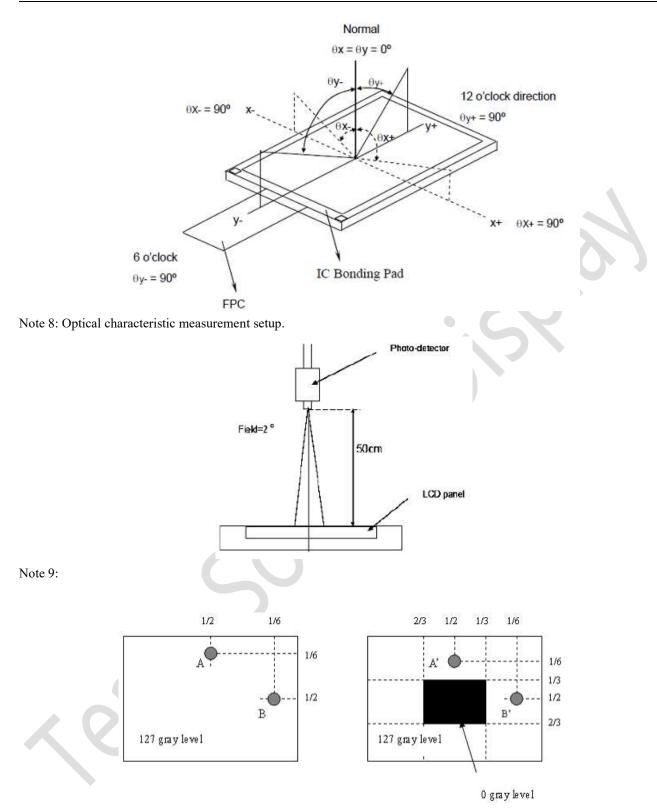
Note 6: Definition of contrast ratio:

Contrast ratio is calculated by the following formula.

Contrast ratio (CR)= Brightness on the "white" state Brightness on the "black" state

Note 7: Definition of viewing angle





1 LA-LA'1 / LA x 100%= 2% max., LA and LA' are brightness at location A and A'.
1 LB-LB'1 / LB x 100%= 2% max., LB and LB' are brightness at location B and B'.

9 RELIABILITY TEST

NO.	TEST ITEM	TEST CONDITION	INSPECTION AFTER TEST
1	High Temperature Storage	80±2°C/96 hours	
2	Low Temperature Storage	-30±2°C/96 hours	
3	High Temperature Operating	70±2°C/96 hours	
4	Low Temperature Operating	-20±2°C/96 hours	Inspection after 2~4 hours storage at room temperature and humidity. The
5	Temperature Cycle	-30±2°C ~ 25~ 80± 2°C × 10 cycles (30 min.) (5min.) (30min.)	condensation is not accepted. The sample shall be free from defects:
6	Damp Proof Test	$60^{\circ}C \pm 5^{\circ}C \times 90\%$ RH/96 hours	1. Air bubble in the LCD
7	Vibration Test	Frequency 10Hz~55Hz Stroke: 1.5mm Sweep: 10Hz~150 Hz~10Hz 2 hours For each direction of X, Y, Z	 Seal leak Non-display Missing segments
8	Shock Test	Half-sine, wave, 300m/s	- 5. Glass crack
9	Packing Drop Test	Height: 80 cm 1 corner, concrete floor	
10	Electrostatic Discharge Test	C=150pF, R=330 Ω Air: ±8KV 150pF/330Ω 30 times Contact: ±4KV,20 times	
11	Image Sticking	25°C,60%RH (ref. to Remark(1))	30mins



5*8 chess pattern

10 Image Sticking

10.1 What is image sticking?

If you remain a fixed image on LCD Display for a long period of time, you may experience a phenomenon called Image Sticking. Image Sticking - sometimes also called "image retention" or "ghosting" - is a phenomenon where a faint outline of a previously displayed image remains visible on the screen when the image is changed. It can occur at variable levels of intensity depending on the specific image makeup, as well as the amount of time the core image elements are allowed to remain unchanged on the screen. In POS applications, for example, a



button menu which remains fixed, or in which the "frame" elements (core image) remain fixed and the buttons may change, may be susceptible to image sticking. It is important to note that if the screen is used exclusively for this application, the user may never notice this phenomenon since the screen never displays other content. It is only when an image other than the "retained" image is shown on the screen that this issue becomes evident. Image sticking is different that the "burn-in" effect commonly associated with phosphor based devices.

10.2 What cause image sticking?

Image sticking is an intrinsic behavior of LCD displays due to the susceptibility to polarization of the interior materials (liquid crystals) when used under static, charged conditions (continuously displaying the same image). The individual liquid crystals in an LCD panel have unique electrical properties. Displaying a fixed pattern - such as the POS menu described above – over prolonged periods can cause a parasitic charge build-up (polarization) within the liquid crystals which affects the crystals' optical properties and ultimately prevents the liquid crystal from returning to its normal, relaxed state when the pattern is finally changed. This effect takes place at a cellular level within the LCD, and the effect can cause charged crystal alignment at the bottom or top of a crystal cell in the

"z" axis, or even crystal migration to the edges of a cell, again based on their polarity. These conditions can cause image sticking over an entire area, or at boundaries of distinct color change respectively. In either case, when the liquid crystals in the pixels and sub-pixels utilized to display the static image are polarized such that they can not return fully to their "relaxed" state upon deactivation, the result is a faint, visible, retained image on the panel upon presentation of a new, different image. The actual rate of image retention depends on variation factors such as the specific image, how long it is displayed unchanged, the temperature within the panel and even the specific panel brand due to manufacturing differences amongst panel manufacturers.

10.3 How to avoid image sticking?

- Try not to operate the LCD with a "fixed" image on the screen for more than 1 hours.

- If you are operating the monitor in an elevated temperature environment and with a displayed image which is contrary to the recommendations in "For Software Developers" below, image stick can occur in as little as 30 minutes. Adjust your screen saver settings accordingly.

- Power down the unit during prolonged periods of inactivity such as the hours a store is closed or a shift during which the piece of equipment isn't used.

- Use a screensaver with a black or medium gray background that is automatically set to come on if the device is inactive for more than 5-10 minutes.

- Avoid placing the monitor in poorly ventilated areas or in areas that will create excess heat around the monitor for software developers.

- In defining the icons, buttons, or windows in the screen, try to utilize block patterns instead of distinct lines as borders for dividing the display into distinct areas.

- If it is necessary to display a static image, try to use colors that are symmetric to the middle grey level at the boundary of two different colors, and slightly shift the borders line once in a while.

- Try to utilize medium gray hues for those areas that will have prolonged display times or remain static as other menu elements change.

10.4 How to fix the image sticking?

Unlike the usually irreversible "burn-in" effects commonly associated with direct view phosphor display devices such as CRTs, an image retained on an LCD display can be reversed – often to a point of total invisibility. However, the severity of the underlying causes (as described above) of the image retained on a specific display, as well as



the variation factors under which the retained image was created, will dictate the final level of retention reversal. One way to erase a retained image on a panel is to run the screen (monitor "on") in an "all black" pattern for 4-6 hours. It is also helpful to do this in an elevated temperature environment of approximately 35° to 50°C. Again, utilizing a dynamic screen saver with an all black background during prolonged idle display periods is a good way to avoid image retention issues.

10.5 Is image sticking covered by TSD warranty?

Image sticking is a phenomenon inherent to LCD Display technology itself, and as such, the occurrence of this "ghosting" effect is considered normal operation by the manufacturers of the LCD display modules which are integrated into today' s monitor solutions. TSD does not warrant any display against the occurrence of image sticking. We strongly advise that you follow the operating recommendations listed above to avoid the occurrence of this phenomenon.

11 Suggestions for using LCD modules

11.1 Handling of LCM

1. The LCD screen is made of glass. Don't give excessive external shock, or drop from a high place.

2. If the LCD screen is damaged and the liquid crystal leaks out, do not lick and swallow. When the liquid

is attach to your hand, skin, cloth etc, wash it off by using soap and water thoroughly and immediately.

3. Don't apply excessive force on the surface of the LCM.

4. If the surface is contaminated, clean it with soft cloth. If the LCM is severely contaminated, use Isopropyl alcohol/Ethyl alcohol to clean. Other solvents may damage the polarizer. The following solvents is especially prohibited: water , ketone Aromatic solvents etc.

5. Exercise care to minimize corrosion of the electrode. Corrosion of the electrodes is accelerated by water droplets, moisture condensation or a current flow in a high-humidity environment.

6. Install the LCD Module by using the mounting holes. When mounting the LCD module make sure it is free of twisting, warping and distortion. In particular, do not forcibly pull or bend the I/O cable or the backlight cable.7. Don't disassemble the LCM.

8. To prevent destruction of the elements by static electricity, be careful to maintain an optimum work environment.

- Be sure to ground the body when handling the LCD modules.
- Tools required for assembling, such as soldering irons, must be properly grounded.
- To reduce the amount of static electricity generated, do not conduct assembling and other work under dry conditions.

- The LCD module is coated with a film to protect the display surface. Exercise care when peeling off this protective film since static electricity may be generated.

9. Do not alter, modify or change the the shape of the tab on the metal frame.

10. Do not make extra holes on the printed circuit board, modify its shape or change the positions of components to be attached.

- 11. Do not damage or modify the pattern writing on the printed circuit board.
- 12. Absolutely do not modify the zebra rubber strip (conductive rubber) or heat seal connector
- 13. Except for soldering the interface, do not make any alterations or modifications with a soldering iron.

14. Do not drop, bend or twist LCM.



11.2 Storage

1. Store in an ambient temperature of 5 to 45 C, and in a relative humidity of 40% to 60%. Don't expose to sunlight or fluorescent light.

2. Storage in a clean environment, free from dust, active gas, and solvent.

3. Store in antistatic container.

12 Limited Warranty

12.1

Our warranty liability is limited to repair and/or replacement. We will not be responsible for any consequential loss.

12.2

If possible, we suggest customer to use up all LCD modules as soon as possible. If the LCD module storage time over twelve months, we suggest to recheck it before being used.

12.3

Any product issues must be feedback to TSD within twelve months since delivery, otherwise, we will not be responsible for the subsequent or consequential events.